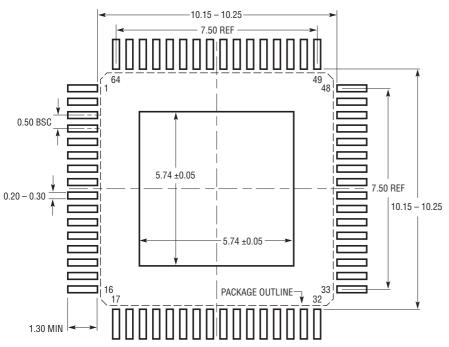
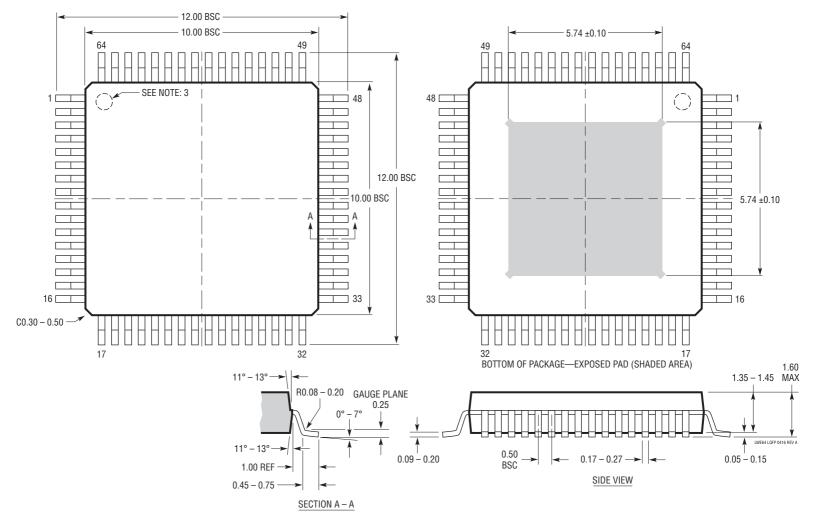
LWE Package 64-Lead Plastic Exposed Pad LQFP (10mm \times 10mm)

(Reference LTC DWG #05-08-1982 Rev A)



RECOMMENDED SOLDER PAD LAYOUT
APPLY SOLDER MASK TO AREAS THAT ARE NOT SOLDERED



NOTE:

- 1. DIMENSIONS ARE IN MILLIMETERS
- 2. DIMENSIONS OF PACKAGE DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED 0.25mm (10 MILS) BETWEEN THE LEADS AND MAX 0.50mm (20 MILS) ON ANY SIDE OF THE EXPOSED PAD, MAX 0.77mm (30 MILS) AT CORNER OF EXPOSED PAD, IF PRESENT
- 3. PIN-1 INDENTIFIER IS A MOLDED INDENTATION, 0.50mm DIAMETER
- 4. DRAWING IS NOT TO SCALE